BAS21QA-Q

High-voltage switching diode

29 January 2025 **Product data sheet**

1. General description

High-voltage switching diode, encapsulated in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} \leq 50$ ns
- Low leakage current: $I_R \leq 100$ nA
- High reverse voltage: $V_R \leq 200$ V
- Low capacitance: $C_d \leq 2$ pF
- Ultra small and leadless SMD plastic package
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- High-speed switching
- General-purpose switching
- Voltage clamping
- Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

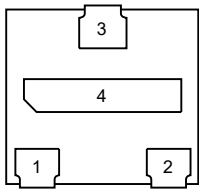
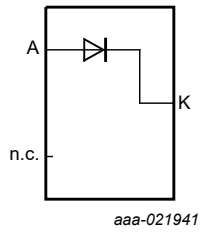
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I_F	forward current	$T_j = 25$ °C	[1]	-	-	330	mA
V_R	reverse voltage			-	-	200	V
V_{RRM}	repetitive peak reverse voltage			-	-	250	V
V_F	forward voltage	$I_F = 200$ mA; $t_p \leq 300$ µs; $\delta \leq 0.02$; $T_j = 25$ °C		-	-	1.25	V
I_R	reverse current	$V_R = 200$ V; pulsed; $T_j = 25$ °C		-	-	100	nA
t_{rr}	reverse recovery time	$I_F = 30$ mA; $I_R = 30$ mA; $R_L = 100$ Ω; $I_{R(meas)} = 3$ mA; $T_j = 25$ °C		-	-	50	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

nexperia

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 Transparent top view **DFN1010D-3 (SOT1215)**	 *aaa-021941*
2	n.c.	not connected		
3	K	cathode		
4	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAS21QA-Q	DFN1010D-3	plastic, leadless thermal enhanced ultra thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.75 mm pitch; 1.1 mm x 1 mm x 0.37 mm body	SOT1215

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS21QA-Q	X 001

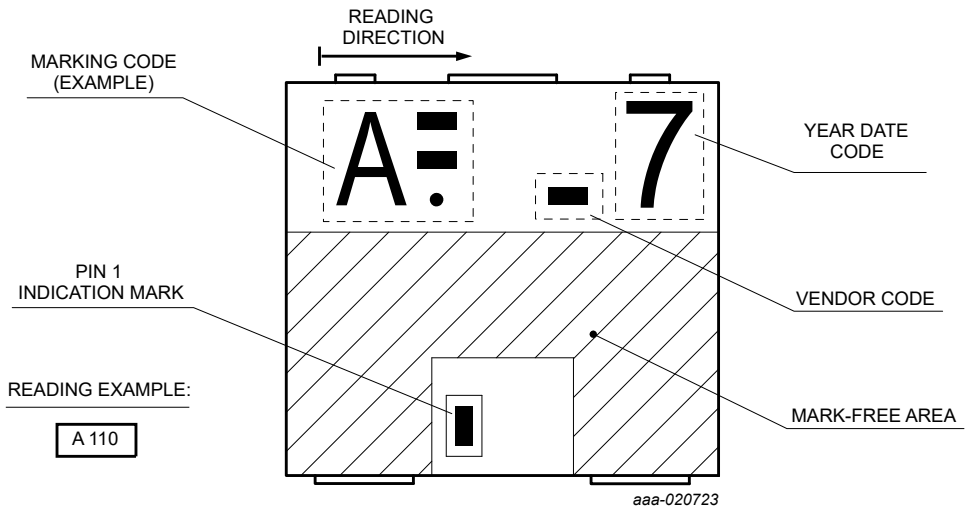


Fig. 1. DFN1010D-3 (SOT1215) binary marking code description

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating Sytem (IEC 60134)

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	T_j = 25 °C		-	250	V
V_R	reverse voltage			-	200	V
I_F	forward current		[1]	-	330	mA
I_{FSM}	non-repetitive peak forward current	t_p = 50 µs; square wave; $T_{j(init)}$ = 25 °C		-	9.4	A
		t_p = 10 ms; square wave; $T_{j(init)}$ = 25 °C		-	1.7	A
I_{FRM}	repetitive peak forward current	$t_p \leq$ 1 ms; $\delta \leq$ 0.25		-	900	mA
P_{tot}	total power dissipation	$T_{amb} \leq$ 25 °C	[1]	-	350	mW
			[2]	-	610	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

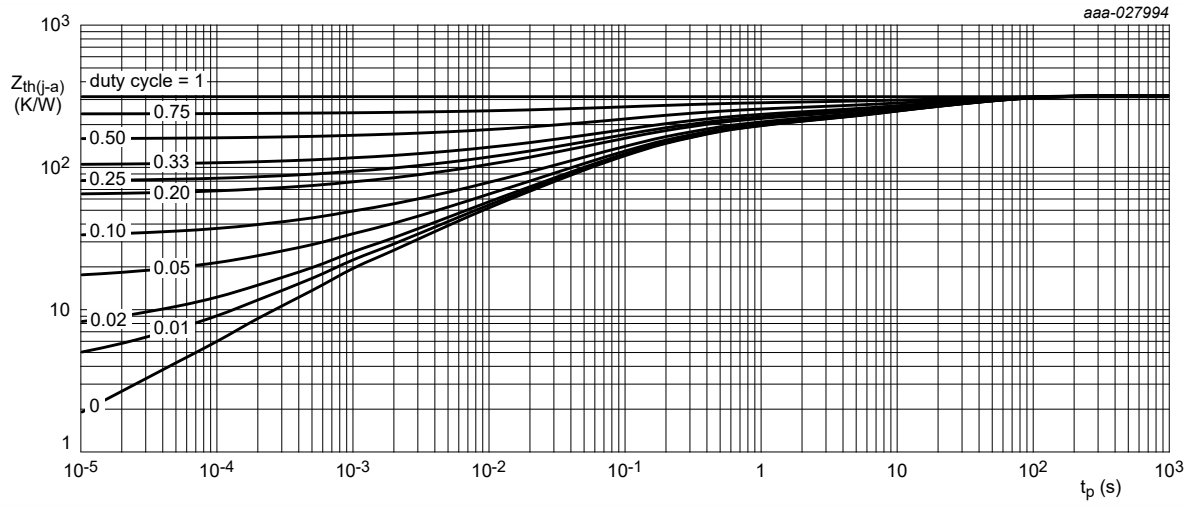
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1cm^2.

9. Thermal characteristics

Table 6. Thermal characteristics

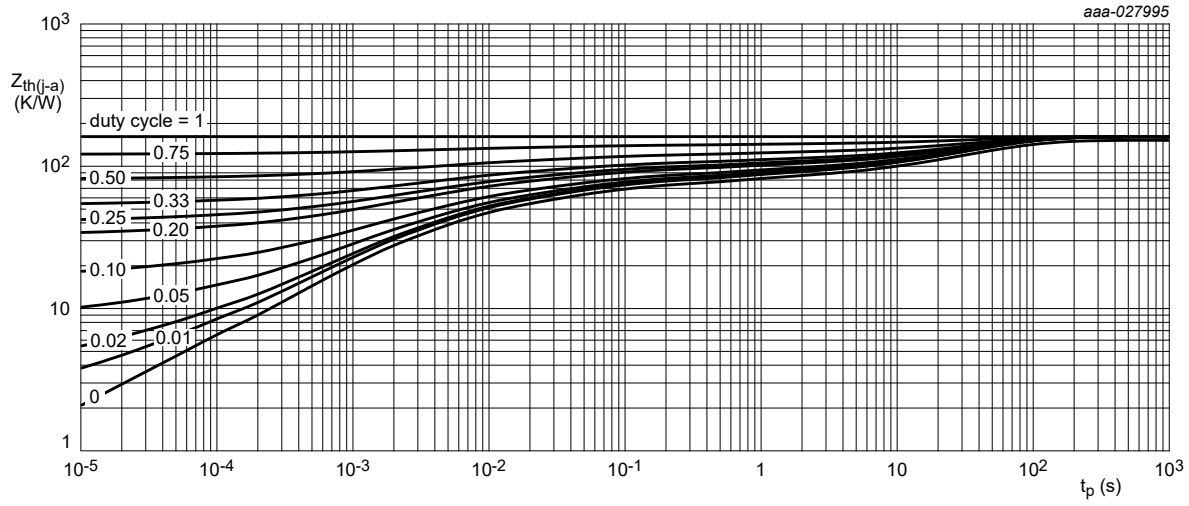
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	In free air	[1]	-	-	355	K/W
			[2]	-	-	205	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	45	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm^2.
[3] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



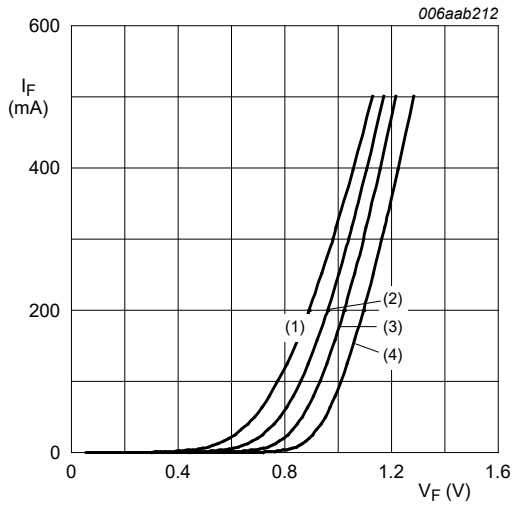
FR4 PCB, mounting pad for cathode 1 cm^2

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

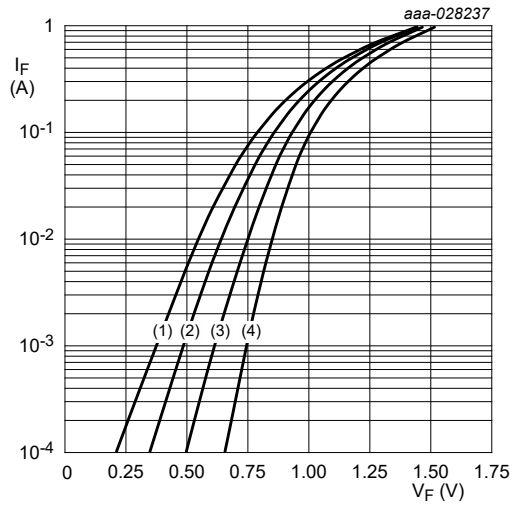
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_F	forward voltage	I_F = 100 mA; $t_p \leq$ 300 µs; $\delta \leq$ 0.02; T_j = 25 °C		-	-	1	V
		I_F = 200 mA; $t_p \leq$ 300 µs; $\delta \leq$ 0.02; T_j = 25 °C		-	-	1.25	V
I_R	reverse current	V_R = 200 V; pulsed; T_j = 25 °C		-	-	100	nA
		V_R = 200 V; pulsed; T_j = 150 °C		-	-	100	µA
C_d	diode capacitance	V_R = 0 V; f = 1 MHz; T_j = 25 °C		-	-	2	pF
t_{rr}	reverse recovery time	I_F = 30 mA; I_R = 30 mA; R_L = 100 Ω; $I_{R(meas)}$ = 3 mA; T_j = 25 °C		-	-	50	ns



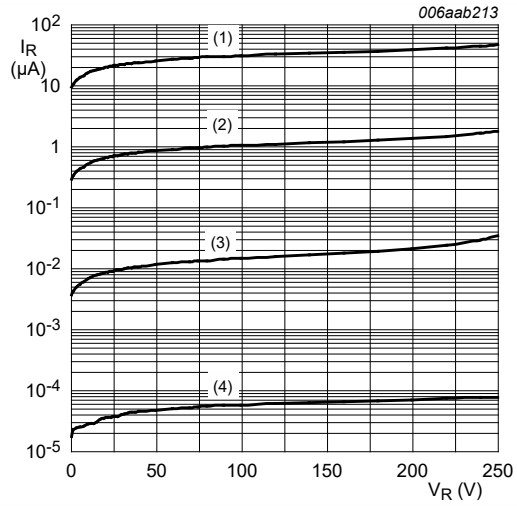
(1) T_{amb} = 150° C
(2) T_{amb} = 85° C
(3) T_{amb} = 25° C
(4) T_{amb} = -40° C

Fig. 4. Forward current as a function of forward voltage; typical values



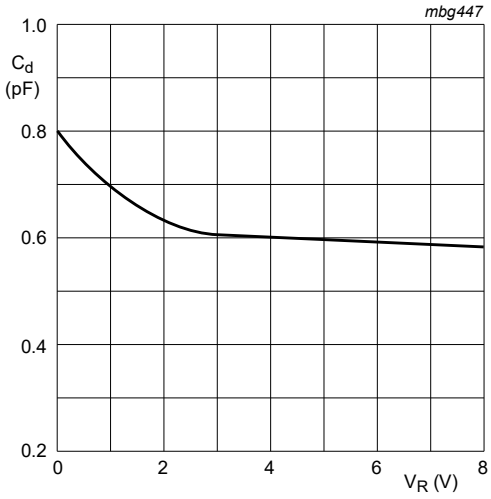
(1) T_j = 150° C
(2) T_j = 85° C
(3) T_j = 25° C
(4) T_j = -40° C

Fig. 5. Forward current as a function of forward voltage; typical values; (logarithmic scale)



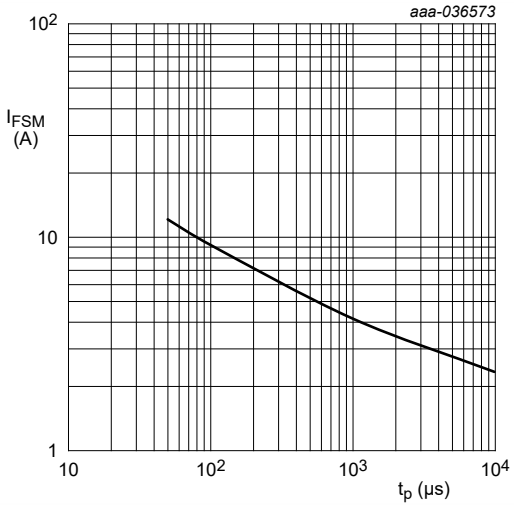
(1) T_{amb} = 150° C
(2) T_{amb} = 85° C
(3) T_{amb} = 25° C
(4) T_{amb} = -40° C

Fig. 6. Reverse current as a function of reverse voltage; typical values



f = 1 MHz
T_j = 25 °C

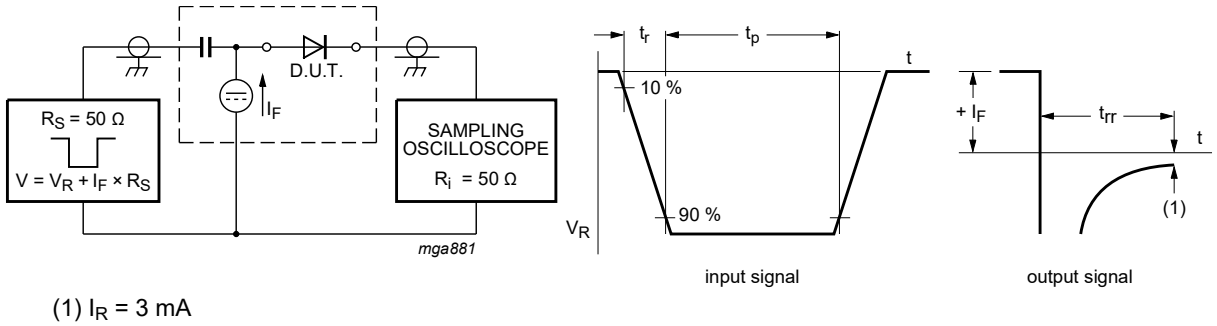
Fig. 7. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.
$T_{j(init)}$ = 25 °C

Fig. 8. Non-repetitive peak forward current as a function of pulse duration; typical values

11. Test information



(1) I_R = 3 mA

Fig. 9. Reverse recovery time test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

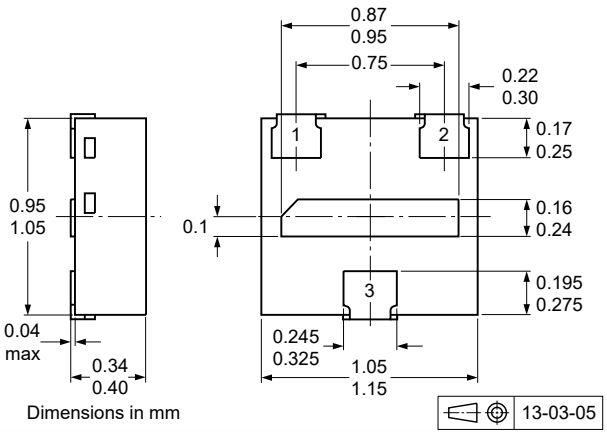


Fig. 10. Package outline DFN1010D-3 (SOT1215)

13. Soldering

Footprint information for reflow soldering of DFN1010D-3 package **SOT1215**

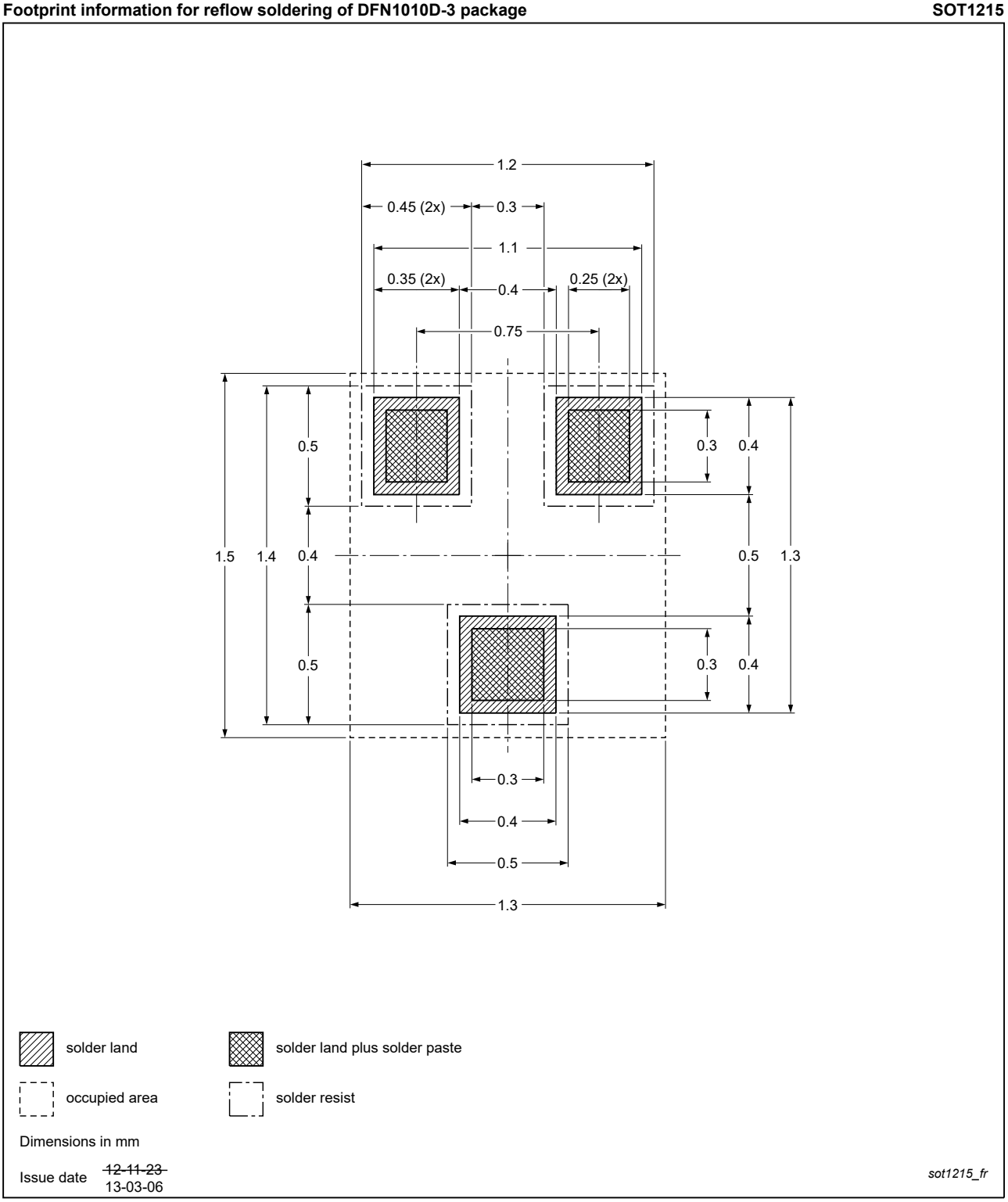


Fig. 11. Reflow soldering footprint for DFN1010D-3 (SOT1215)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS21QA-Q v.2	20250129	Product data sheet	-	BAS21QA-Q v.1
Modifications:	• Limiting values: I_{FSM} values changed • Characteristics: Fig 8. changed			
BAS21QA-Q v.1	20240422	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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